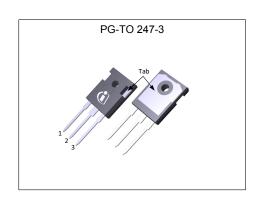


MOSFET

650V CoolMOS™ CFD7 SJ Power Device

The latest 650 V CoolMOS™ CFD7 extends the voltage class offering of the CFD7 family and is a successor to the 650 V CoolMOS™ CFD2. Resulting from improved switching performance and excellent thermal behavior, 650 V CooMOS™ CFD7 offers highest efficiency in resonant switching topologies, such as LLC and phase-shift-full-bridge (ZVS). As part of Infineon's fast body diode portfolio, this new product series blends all advantages of a fast switching technology together with superior hard commutation robustness. The CoolMOS™ CFD7 technology meets highest efficiency and reliability standards and furthermore supports high power density solutions.



Features

- · Ultra-fast body diode
- 650V break down voltage
- Best-in-class R_{DS(on)}
- Reduced switching losses
- Low R_{DS(on)} dependency over temperature

Benefits

- Excellent hard commutation ruggedness
- · Extra safety margin for designs with increased bus voltage
- Enabling increased power density solutions
- Outstanding light load efficiency in industrial SMPS applications
- Improved full load efficiency in industrial SMPS applications
- Price competitiveness over previous CoolMOS™ families

Potential applications

Suitable for Soft Switching topologies Optimized for phase-shift full-bridge (ZVS), LLC Applications – Server, Telecom, EV Charging, Solar



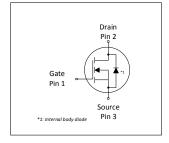
Fully qualified according to JEDEC for Industrial Applications

Please note: For MOSFET paralleling the use of ferrite beads on the gate or separate totem poles is generally recommended.



| Parameter | Value | Unit | | | | | |
|--------------------------------------|-------|------|--|--|--|--|--|
| V _{DS} @ T _{j,max} | 700 | V | | | | | |
| R _{DS(on),max} | 60 | mΩ | | | | | |
| $Q_{g,typ}$ | 68 | nC | | | | | |
| I _{D,pulse} | 146 | A | | | | | |
| E _{oss} @ 400V | 9.5 | μJ | | | | | |
| Body diode di _F /dt | 1300 | A/µs | | | | | |

| Type / Ordering Code | Package | Marking | Related Links |
|----------------------|------------|----------|----------------|
| IPW65R060CFD7 | PG-TO247-3 | 65R060F7 | see Appendix A |









650V CoolMOS™ CFD7 SJ Power Device IPW65R060CFD7



Table of Contents

| escription1 |
|------------------------------------|
| 1aximum ratings |
| hermal characteristics4 |
| lectrical characteristics 5 |
| lectrical characteristics diagrams |
| est Circuits |
| ackage Outlines |
| ppendix A |
| evision History |
| rademarks |
| nisclaimer |

650V CoolMOS™ CFD7 SJ Power Device IPW65R060CFD7



1 Maximum ratings at $T_j = 25$ °C, unless otherwise specified

Table 2 Maximum ratings

| Danamatan | Values | | | | 11 | Note / Took Condition | |
|--|------------------------|------|------|----------|------|---|--|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition | |
| Continuous drain current ¹⁾ | I _D | - | - | 36 23 | А | T _C =25°C T _C =100°C | |
| Pulsed drain current ²⁾ | I _{D,pulse} | - | - | 146 | Α | T _C =25°C | |
| Avalanche energy, single pulse | E _{AS} | - | - | 171 | mJ | I _D =5.1A; V _{DD} =50V; see table 10 | |
| Avalanche energy, repetitive | E AR | - | - | 0.86 | mJ | I _D =5.1A; V _{DD} =50V; see table 10 | |
| Avalanche current, single pulse | I _{AS} | - | - | 5.1 | Α | - | |
| MOSFET dv/dt ruggedness | dv/dt | - | - | 120 | V/ns | V _{DS} =0400V | |
| Gate source voltage (static) | V _{GS} | -20 | - | 20 | V | static; | |
| Gate source voltage (dynamic) | V _{GS} | -30 | - | 30 | V | AC (f>1 Hz) | |
| Power dissipation | P _{tot} | - | - | 171 | W | T _C =25°C | |
| Storage temperature | $T_{ m stg}$ | -55 | - | 150 | °C | - | |
| Operating junction temperature | T _j | -55 | - | 150 | °C | - | |
| Mounting torque | - | - | - | 60 | Ncm | M3 and M3.5 screws | |
| Continuous diode forward current ¹⁾ | I _S | - | - | 36 | Α | <i>T</i> _C =25°C | |
| Diode pulse current ²⁾ | I _{S,pulse} | - | - | 146 | Α | <i>T</i> _C =25°C | |
| Reverse diode dv/dt ³⁾ | dv/dt | - | - | 70 | V/ns | V _{DS} =0400V, I _{SD} <=16.4A, T _j =25°C see table 8 | |
| Maximum diode commutation speed | di _F /dt | - | - | 1300 | A/μs | V_{DS} =0400V, I_{SD} <=16.4A, T_{j} =25°C see table 8 | |
| Insulation withstand voltage | V _{ISO} | - | - | n.a. | V | V _{rms} , T _C =25°C, t=1min | |

 $^{^{1)}}$ Limited by $T_{j\,\text{max}}.$ $^{2)}$ Pulse width t_p limited by $T_{j,\text{max}}$ $^{3)}$ Identical low side and high side switch with identical R_G

650V CoolMOS™ CFD7 SJ Power Device IPW65R060CFD7



2 Thermal characteristics

Table 3 Thermal characteristics

| Davamatav | Complete | Values | | | 11:4 | Nata / Tank Canadition |
|--|-------------------|--------|------|----------|------|-------------------------------------|
| Parameter | Symbol | Min. | Тур. | yp. Max. | | Note / Test Condition |
| Thermal resistance, junction - case | R _{thJC} | - | - | 0.73 | °C/W | - |
| Thermal resistance, junction - ambient | | - | - | 62 | °C/W | leaded |
| Thermal resistance, junction - ambient for SMD version | R_{thJA} | - | - | - | °C/W | n.a. |
| Soldering temperature, wavesoldering only allowed at leads | T _{sold} | - | - | 260 | °C | 1.6mm (0.063 in.) from case for 10s |

650V CoolMOS™ CFD7 SJ Power Device IPW65R060CFD7



Electrical characteristics

at T_j=25°C, unless otherwise specified

Table 4 **Static characteristics**

| Danamatan | Oh o.l | | Values | | | |
|---|-----------------------|------|----------------|---------|------|---|
| Parameter | Symbol | Min. | Тур. | | Unit | Note / Test Condition |
| Drain-source breakdown voltage | V _{(BR)DSS} | 650 | - | - | V | V_{GS} =0V, I_{D} =1mA |
| Gate threshold voltage | V _{(GS)th} | 3.5 | 4 | 4.5 | V | $V_{\rm DS}=V_{\rm GS},\ I_{\rm D}=0.86{\rm mA}$ |
| Zero gate voltage drain current ¹⁾ | I _{DSS} | - | - 13 | 1 37 | μΑ | V _{DS} =650V, V _{GS} =0V, T _j =25°C V _{DS} =650V, V _{GS} =0V, T _j =125°C |
| Gate-source leakage current | I _{GSS} | - | - | 100 | nA | V _{GS} =20V, V _{DS} =0V |
| Drain-source on-state resistance | R _{DS(on)} | - | 0.052 0.115 | 0.060 | Ω | V _{GS} =10V, I _D =16.4A, T _j =25°C V _{GS} =10V, I _D =16.4A, T _j =150°C |
| Gate resistance | R _G | - | 5.8 | - | Ω | f=1MHz, open drain |

Table 5 **Dynamic characteristics**

| Parameter | Oh all | | Value | s | | |
|--|--------------------|------|-------|------|------|--|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition |
| Input capacitance | Ciss | - | 3288 | - | pF | V _{GS} =0V, V _{DS} =400V, f=250kHz |
| Output capacitance | Coss | - | 51 | - | pF | V _{GS} =0V, V _{DS} =400V, f=250kHz |
| Effective output capacitance, energy related ²⁾ | C _{o(er)} | - | 119 | - | pF | V _{GS} =0V, V _{DS} =0400V |
| Effective output capacitance, time related ³⁾ | C _{o(tr)} | - | 1231 | - | pF | I _D =constant, V _{GS} =0V, V _{DS} =0400V |
| Turn-on delay time | t _{d(on)} | - | 31 | - | ns | $V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =16.4A, $R_{\rm G}$ =5.3 Ω ; see table 9 |
| Rise time | t _r | - | 14 | - | ns | $V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =16.4A, $R_{\rm G}$ =5.3 Ω ; see table 9 |
| Turn-off delay time | $t_{ m d(off)}$ | - | 114 | - | ns | $V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =16.4A, $R_{\rm G}$ =5.3 Ω ; see table 9 |
| Fall time | t _f | - | 4 | - | ns | $V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =16.4A, $R_{\rm G}$ =5.3 Ω ; see table 9 |

Table 6 **Gate charge characteristics**

| Values | | | Note / Test Condition | | | |
|-----------------------|----------------------|----------------|-----------------------|-----------------------|----|--|
| Parameter | Symbol | Min. Typ. Max. | Unit | Note / Test Condition | | |
| Gate to source charge | Q _{gs} | - | 19 | - | nC | V_{DD} =400V, I_{D} =16.4A, V_{GS} =0 to 10V |
| Gate to drain charge | Q _{gd} | - | 21 | - | nC | V_{DD} =400V, I_{D} =16.4A, V_{GS} =0 to 10V |
| Gate charge total | Qg | - | 68 | - | nC | V_{DD} =400V, I_{D} =16.4A, V_{GS} =0 to 10V |
| Gate plateau voltage | V _{plateau} | - | 5.7 | - | V | V_{DD} =400V, I_{D} =16.4A, V_{GS} =0 to 10V |

 $^{^{1)}}$ Maximum specification is defined by calculated six sigma upper confidence bound $^{2)}$ $C_{\rm o(er)}$ is a fixed capacitance that gives the same stored energy as $C_{\rm oss}$ while $V_{\rm DS}$ is rising from 0 to 400V $^{3)}$ $C_{\rm o(tr)}$ is a fixed capacitance that gives the same charging time as $C_{\rm oss}$ while $V_{\rm DS}$ is rising from 0 to 400V

650V CoolMOS™ CFD7 SJ Power Device

IPW65R060CFD7

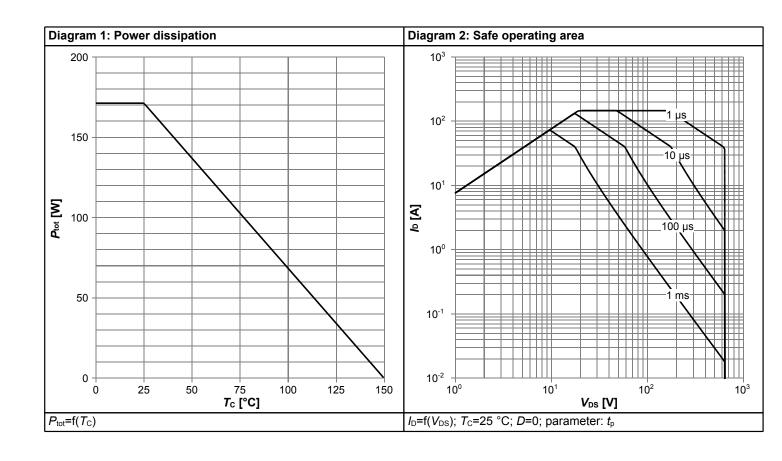


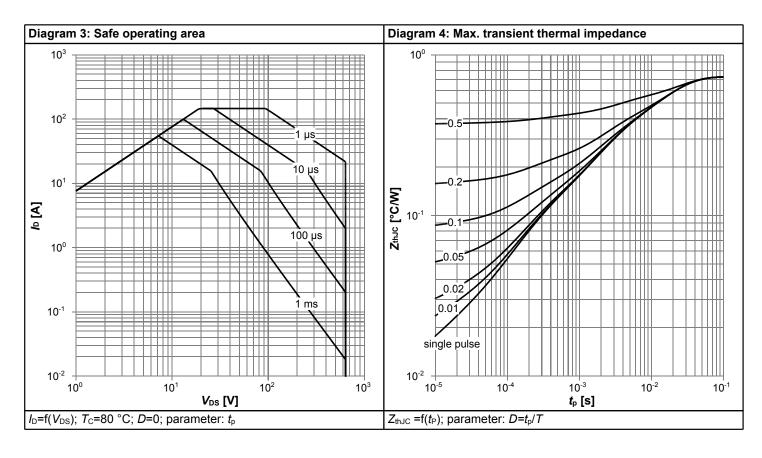
Table 7 Reverse diode characteristics

| Davamatav | Symbol | | Values | | Linit | Note / Test Condition | |
|-------------------------------|------------------------|------|--------|---------------|-------|--|--|
| Parameter | Symbol | Min. | Тур. | yp. Max. Unit | Unit | Note / Test Condition | |
| Diode forward voltage | V _{SD} | - | 1.0 | - | V | V _{GS} =0V, I _F =16.4A, T _j =25°C | |
| Reverse recovery time | t _{rr} | - | 156 | 234 | ns | V_R =400V, I_F =16.4A, di_F/dt =100A/ μ s; see table 8 | |
| Reverse recovery charge | Q _{rr} | - | 0.86 | 1.72 | μC | V_R =400V, I_F =16.4A, di_F/dt =100A/ μ s; see table 8 | |
| Peak reverse recovery current | I _{rrm} | - | 10.1 | - | Α | V_R =400V, I_F =16.4A, di_F/dt =100A/ μ s; see table 8 | |

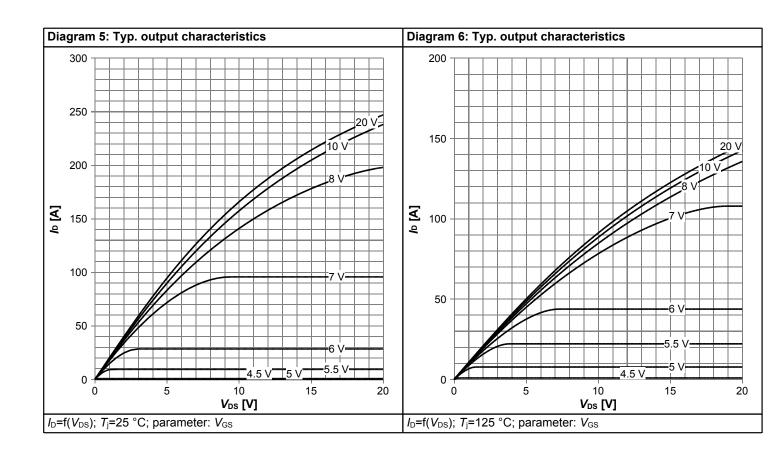


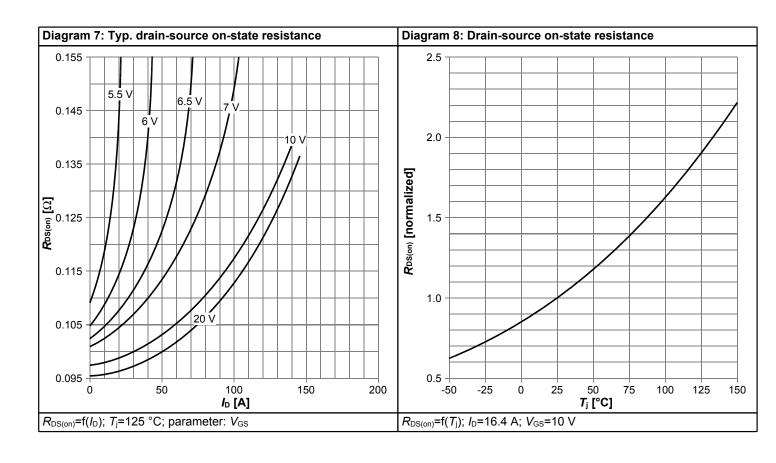
4 Electrical characteristics diagrams



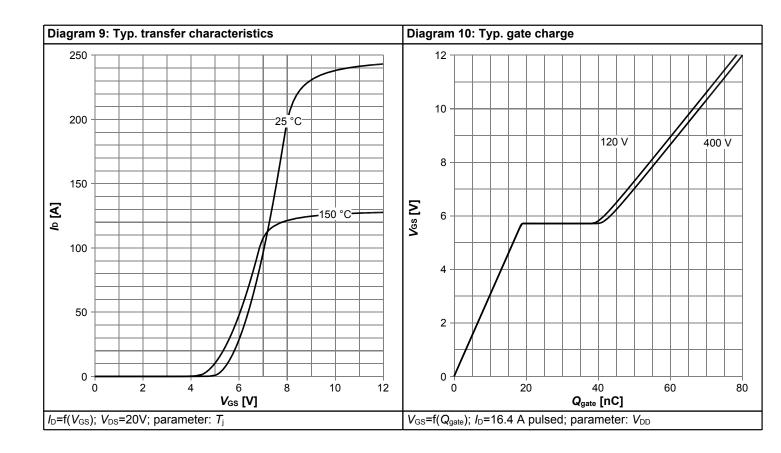


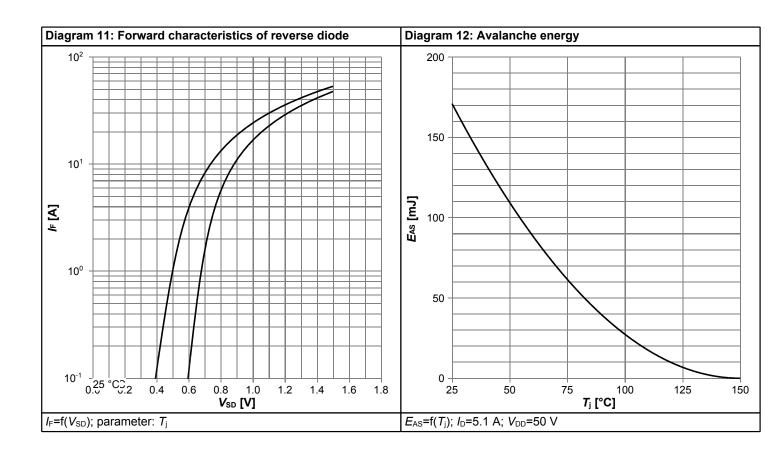






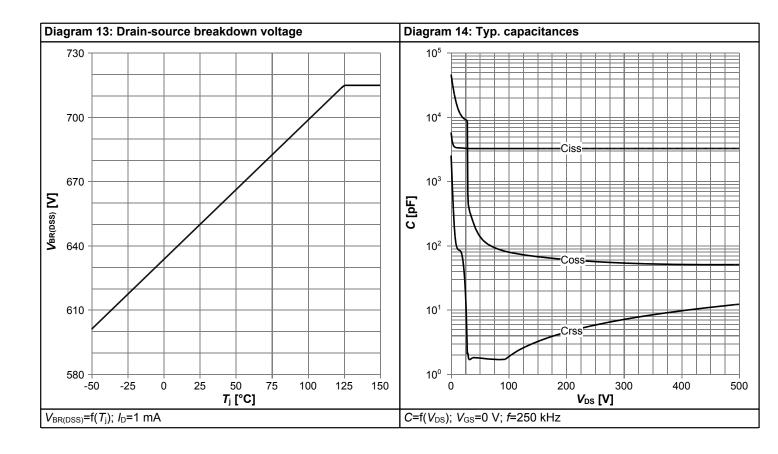


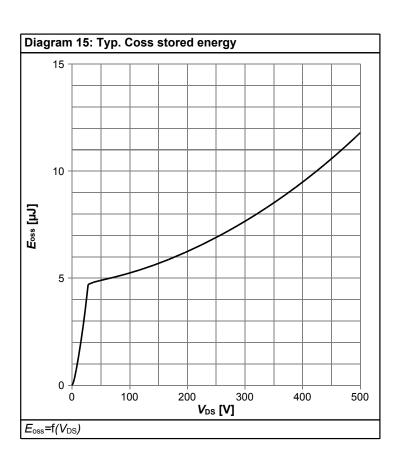




IPW65R060CFD7









5 Test Circuits

Table 8 Diode characteristics

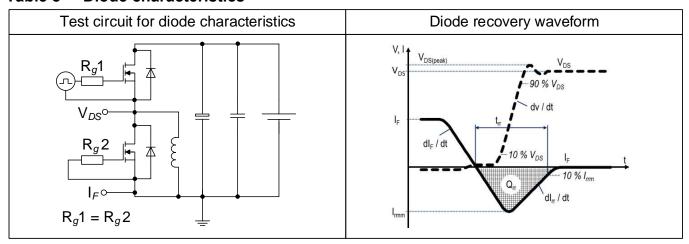
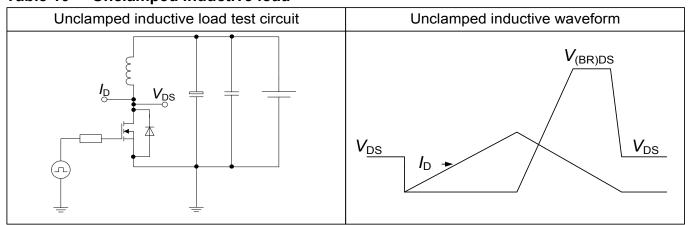


Table 9 Switching times

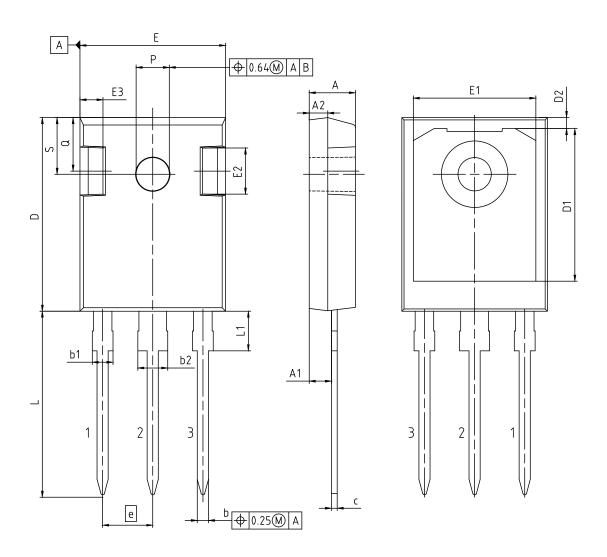


Table 10 Unclamped inductive load





6 Package Outlines



| DIMENSIONS | MILLIM | ETERS | |
|------------|--------|-------|---------------------|
| DIMENSIONS | MIN. | MAX. | |
| Α | 4.70 | 5.30 | |
| A1 | 2.20 | 2.60 | |
| A2 | 1.50 | 2.50 | |
| b | 1.00 | 1.40 | |
| b1 | 1.60 | 2.41 | DOCUMENT NO. |
| b2 | 2.57 | 3.43 | Z8B00003327 |
| С | 0.38 | 0.89 | REVISION |
| D | 20.70 | 21.50 | 06 |
| D1 | 13.08 | 17.65 | |
| D2 | 0.51 | 1.35 | SCALE 3:1 |
| E | 15.50 | 16.30 | 0 1 2 3 4 5mm |
| E1 | 12.38 | 14.15 | السلسا |
| E2 | 3.40 | 5.10 | |
| E3 | 1.00 | 2.60 | EUROPEAN PROJECTION |
| е | 5. | 44 | |
| L | 19.80 | 20.40 | |
| L1 | 3.85 | 4.50 | |
| Р | 3.50 | 3.70 |] |
| Q | 5.35 | 6.25 | ISSUE DATE |
| S | 6.04 | 6.30 | 25.07.2018 |

Figure 1 Outline PG-TO247-3, dimensions in mm

650V CoolMOS™ CFD7 SJ Power Device IPW65R060CFD7



7 Appendix A

Table 11 Related Links

• IFX CoolMOS CFD7 650V Webpage: www.infineon.com

• IFX CoolMOS CFD7 650V application note: www.infineon.com

• IFX CoolMOS CFD7 650V simulation model: www.infineon.com

• IFX Design tools: www.infineon.com

650V CoolMOS™ CFD7 SJ Power Device

IPW65R060CFD7



Revision History

IPW65R060CFD7

Revision: 2020-08-12, Rev. 2.1

| D | D |
|----------|----------|
| Previous | Revision |

| Revision | Date | Date Subjects (major changes since last revision) | | | | | |
|----------|------------|---|--|--|--|--|--|
| 2.0 | 2020-06-23 | Release of final version | | | | | |
| 2.1 | 2020-08-12 | Increased continuous diode forward current rating | | | | | |

Trademarks

All referenced product or service names and trademarks are the property of their respective owners.

We Listen to Your Comments

Any information within this document that you feel is wrong, unclear or missing at all? Your feedback will help us to continuously improve the quality of this document. Please send your proposal (including a reference to this document) to: erratum@infineon.com

Published by Infineon Technologies AG 81726 München, Germany © 2020 Infineon Technologies AG All Rights Reserved.

Legal Disclaimer

The information given in this document shall in no event be regarded as a guarantee of conditions or characteristics ("Beschaffenheitsgarantie").

With respect to any examples, hints or any typical values stated herein and/or any information regarding the application of the product, Infineon Technologies hereby disclaims any and all warranties and liabilities of any kind, including without limitation warranties of non-infringement of intellectual property rights of any third party.

In addition, any information given in this document is subject to customer's compliance with its obligations stated in this document and any applicable legal requirements, norms and standards concerning customer's products and any use of the product of Infineon Technologies in customer's applications.

The data contained in this document is exclusively intended for technically trained staff. It is the responsibility of customer's technical departments to evaluate the suitability of the product for the intended application and the completeness of the product information given in this document with respect to such application.

Information

For further information on technology, delivery terms and conditions and prices please contact your nearest Infineon Technologies Office (www.infineon.com).

Warnings

Due to technical requirements, components may contain dangerous substances. For information on the types in question, please contact the nearest Infineon Technologies Office.

The Infineon Technologies component described in this Data Sheet may be used in life-support devices or systems and/or automotive, aviation and aerospace applications or systems only with the express written approval of Infineon Technologies, if a failure of such components can reasonably be expected to cause the failure of that life-support, automotive, aviation and aerospace device or system or to affect the safety or effectiveness of that device or system. Life support devices or systems are intended to be implanted in the human body or to support and/or maintain and sustain and/or protect human life. If they fail, it is reasonable to assume that the health of the user or other persons may be endangered.

Final Data Sheet 14 Rev. 2.1, 2020-08-12